TATA INSTITUTE OF FUNDAMENTAL RESEARCH

Plot No.36/P, Gopanpally Village, Serilingampally Mandal, Ranga Reddy District. Hyderabad - 500 107, Telangana, India.

Telephone: +91-40-2020 3020 Email: purchasegroup@tifrh.res.in

Website: www.tifrh.res.in

Date: 18-05-2018

Notice Inviting Tender cum Tender Document (Two Part Public Tender) for the following items:

Supply, Installation, Commissioning of High Performance Computing (HPC) Cluster for TIFR Hyderabad.

As per our technical specifications: Qty. - 1 No.

	TED /DD /1640 00 /D 50 /400050
Public Tender No.	TFR/PD/IC18-03/F-78/180078
Published on	19-05-2018
	For Indian Supplier - Rs. 700/-
Tender Fees	For Foreign Supplier-USD 100
	For Indian Supplier - Rs. 3,90,000/-
EMD	For Foreign Supplier - USD 5700
Estimated Cost	Rs. 195 Lakhs
Pre Bid Meeting	25-05-2018 at 11.00 AM
Last Date for Submission of Bid	11-06-2018 upto 13.00 Hrs.
Date of Opening Bids(Part A)	11-06-2018 at 15.00 Hrs.

Both Technical Bid (Part A) and Financial Bid (Part B) to be submitted within the due date and time in separate envelopes and marked on top as Part A and Part B. These two sealed envelopes should be further put in one Master Envelope superscribed with the Tender No., Due Date in Bold Letters.

Please see attached sheet for conditions of tender.

Note: All future corrigendum/addendum will be published in TIFR Hyderabad website only. All prospective bidders are requested to visit our website regularly for any such updates/Corrigendum/Addendum.

ADMINISTRATIVE OFFICER (PURCHASE SECTION) TIFR, HYDERABAD

SCOPE OF SUPPLY - Annexure A

Supply, Installation and Commissioning of High Performance Computing (HPC) Cluster

Technical pre-qualification for the bidders

Mandatory requirements for a bidder to qualify as a participant in this tender:

Mand	Mandatory requirements for a bidder to qualify as a participant in this tender:							
S.No	Technical pre-qualification criteria	Compliance Yes/No	Remarks					
1.	The bidder/OEM should have executed at least three projects using architecture and technologies similar to those being proposed in their quotation against this tender. In addition, the following condition should also be satisfied.	,						
	 At least one installation of minimum 75 TF (Tera Flops) or At least two installations of 60 TF or At least three installations of 40 TF 							
	Purchase order/final commissioning report copies of the same must be submitted with the technical bid.							
	Note: For the above mentioned criteria, only x86/equivalent based CPU-only HPC cluster orders will be considered. HPCC with Accelerators like NVIDIA Tesla GPUs, Xeon Phis or KNL, etc., based HPCC along CPU nodes will not be considered.							
2.	The OEM or partner should have successfully executed projects at Government/ Public/ Private Research organizations /institutions performing scientific computation using High Performance Computing Clusters across the globe.							
	Purchase order/final commissioning report with compute capacity and architecture details duly signed by customer should be submitted with the technical bid.							
3.	The Bidder and OEM should have the experience in building HPC Clusters in global HPC Market since last 3 years with logistics facility in India for easy access and availability of spares and to ensure the proper back-end support for smooth execution and post-sale support operations. Documentary proofs should be attached.							
4.	The OEM should have minimum one entry in the latest top 500 supercomputer India list maintained by SERC, IISc and CDAC India (which can be downloaded at http://topsc.cdacb.in/ or https://cc.tifrh.res.in/webdata/documents/events/benchm arks/topsc-Jan-2018-cdac.pdf) or should have minimum 10 entries in the latest world top 500 supercomputer list. (available at www.top500.org)							

5.	All warranty and support must be serviced directly by the	
	OEM or should be from an Authorized System Integrator	
	Partner who is Authorized to Support the product quoted.	
	TIFR-H requires that there be a Single Point Of Contact	
	(SPOC) from OEM/Vendor who is responsible for all issues	
	between TIFR-H and the OEM.	
6.	The bidder should have average annual sales turnover of Rs.	
	10 Crores or more during the last three financial years	
	ending 31st March, 2017. Attach firm's last 3 years audited	
	profit and loss balance sheet duly audited by C.A	
	Attached at Annexure – E should be certified by Chartered	
	Accountant (CA).	
	(61-)	
	The format is given at Annexure – E and should be duly	
	signed and stamped by the CA on the letterhead.	
7.	Bidder should be either an Original Equipment	
'`	Manufacturer (OEM) or should be authorized System	
	Integrator Partner having back to back Support Agreement	
	with the OEM. Manufacturer's Authorization Form (MAF) for	
	3 5	
	participating in this tender is mandatory for bidders and	
	should be attached along with technical bid. The Bidder	
	participating in the tender process should give the MAF	
	confirming the bidder's authorization to participate in the	
	tender with tender number and details.	
8.	Hardware and software warranty support requests to be	
	handled and serviced directly by OEM/Bidder. OEM/Bidder	
	should have required critical spares at local service center.	
9.	OEM/Bidder should have a local service center within the	
	radius of 1000 Km from Hyderabad. The OEM/Vendor	
	should have service engineers in the relevant field of quoted	
	item.	
10.	The OEM/Bidder must have an India based support	
	infrastructure by maintaining a local spares depot in the	
	country. This is to ensure immediate delivery of spare parts	
	from OEM to its channel partner/system integrator.	
11.	1	
	hardware. The OEM and Bidder should have valid ISO	
	certification. Please attach a copy of the certificate.	
12.	The complete proposed solution must have all	
	encompassing comprehensive onsite advance replacement	
	warranty of 5 years duration which includes hardware,	
	software, firmware, software updates, etc., If the hardware	
	replacement process takes more than two days, the	
	bidder/OEM should provide a standby hardware till the	
	replacement is made.	
13.	Products offered should have official OEM support for next	
	three years from the date of acceptance of installation.	
14.	The entire HPCC solution proposed by the bidder/OEM	
	should be offered with lowest power consumption for the	
	given specification in the tender.	

15.	All quotatio8ns submitted must follow the prescribed format	
	for technical compliance as in document below. Failure to do	
	will result in the quotation being summarily rejected. Soft	
	copy of the technical bid document in excel format should	
	also be submitted. Soft Copy should be provided in a read	
	only format with CD/DVD.	
16.	One bidder can propose only one technical solution and the	
	price bid for the same should be submitted. Quoting of	
	multiple technical solutions with multiple price bids will	
	result in the quotation being summarily rejected.	

Annexure - B

TECHNICAL QUALIFYING CRITERIA

High Performance Computing Cluster

The OEM/bidder should carry out below listed benchmark programs on 256 Cores, 512 Cores and 1024 Cores peak performance configurations of the proposed solution. In case, if the full scale cluster is not available for the bidders/OEM, they can produce the extrapolated outputs of the fully offered solution in peak performance configurations. Benchmark codes can be run on the processor architecture quoted for the tender and the results can be submitted. The produced results should match with the results of the offered solution as a part of the acceptance test. The maximum allowable deviation from the extrapolated results in the acceptance test should not be less than 3%. The results (with TFLOP count where applicable) should be presented in an output file and included in the technical bid.

- 1. Demonstration of High Performance Linpack (HPL) Benchmark performance of minimum 76 % per compute node.
- 2. Other applications for Benchmark LAMMPS, P3DFFT, GROMACS. (https://cc.tifrh.res.in/webdata/documents/events/benchmarks/benchmarking.zip

Note: All the above benchmark codes except HPL should be run using open source gnu compilers 4.8.5 or above, openmpi 2.0 or above. Other commercial compilers or any code optimizations are not allowed for benchmarking.

Provide read-only output of the above benchmark on DVD/CD along with the bid. Do not provide the print out of the outputs. Proposals of vendors who do not fulfill the above criteria or who fail to submit documentary proof would be rejected.

Annexure - C

Scope of Work

Scope of work includes the following

Supply, Installation and Commissioning of High Performance Computing Cluster as per the specifications below

The entire HPC solution (Master and Compute nodes) should be designed using same processor architecture and should fit into the smart cooling server rack provided by TIFR-H. And the entire solution fit within 24U rack space and the power consumption at full load (linpack) should be less than 19 KW.

Technical Specifications

Specifications of the High Performance Computing cluster

Mandatory Clause

- a) All warranty and support must be serviced directly by the OEM or should be from an Authorized System Integrator Partner who is authorized to Support the product quoted. TIFR-H requires that there be a Single Point of Contact (SPOC) from OEM/Bidder who is responsible for all issues between TIFR-H and the OEM.
- b) All the hardware and software deployment will be in vendor's scope of work and vendors need to install open source software required by the end user at the time of deployment.
- c) The Master, compute and storage nodes should be in denser rack form factor designed for cluster solution.
- d) The entire server, storage and compute nodes must be factory integrated, tested, validated and certified in the bidder/OEM site. No on-site or local assembling of the system at TIFR-H site is allowed. Only rack-mounting, OS and application installation is allowed on-site.

Mandatory items

	Computer Hardware		•	Model/Remared by the Vend	
S.No	Description	Qt y	Make & Model	Complianc e Yes/No	Re ma rks
1	Master + Storage Node	1			

Master node should have minimum 16 cores x86/equivalent based dual socket server having 16 double precision instructions/cycle having support with a minimum memory of 3 GB/Core or better in a fully balanced configuration. Operating System should be installed in a separate 900 GB 10K SAS Enterprise Hard drives configured in RAID 1 and Storage space with 4 x 10 TB 7.2 K SAS Enterprise Hard drives configured in RAID 5 using 2 GB RAID card with FBWC

	(Flash Backed Write Cache). The RAID card should be expandable for adding HDDs in future and also it should support ZFS. Master node should be provided with minimum four Gigabit Ethernet and one management port for IPMI 2.0 or equivalent Support with KVM and Media over LAN features. (Must include any licenses, if required for using these features). The Master node form factor should not be more than 2U. The compute connectivity will be using through 1 G Ethernet cables or better. Master node should be provided with 80 Plus Platinum or better certified Redundant Power Supply.					
	Processor Details					
	Chipset Details					
	Hard Drives Details					
	RAID Card Details					
	Memory Configuration Details					
	Compute and management connectivity					
	Form Factor					
	Power Supply Unit Details					
2	Compute Nodes		1152 c	ompute cores		
	To achieve minimum 1152 compute cores using 32 double precision instructions/cycle with mi in the factor of 2 power n (2^n) at the base clock having support with a minimum 12 GB memo	nimu ck spe ry/co	m 32 core eed of min re or bett	s per node or imum 2.1 GHz er in fully bal	more /core anced	
	configuration. Each node should be provided SATA SSD/M.2 SSD for operating System and 4 scratch using minimum 1 GB RAID card with FE with minimum two Gigabit Ethernet and one equivalent Support with KVM and Media over licenses, if required for using these features). In nodes will be using through 1 G Ethernet call should be in minimum 2U 4 Nodes or even of should be accommodated in a rack space not node solution should be provided with 80 Redundant Power Supply to ensure there is no second	TB of manar LANThe coles of dense more	configured Each node agement p I features ompute co r better.' r. The en than 18U Platinum	in RAID 1 for should be proport for IPMI 2 (Must include onnectivity between tire compute and each cor better centrely and each ce	vided vided 2.0 or e any tween nodes nodes npute	
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	Power Supply Unit Details			
3	Network/Interconnect & Connectivity	2		
	Rack mountable 48 Port L2 Managed Gigabit			
	switches for IPMI management and Compute			
	connectivity with required peripheral for rack			
	mounting. All required accessories including			
	Ethernet cables to achieve the non-blocking			
	interconnection should be considered. Required power cables for the equipment /			
	devices of type - IEC C13/C14 and IEC			
	C19/C20 from OEM should be considered.			
	All Network/Interconnect cabling must be			
	structured and adhere to ANSI/TIA - 568			
	Standard.			
	Note: Cables should be lengthy to connect			
	across racks, in case the cluster load is			
	distributed across multiple racks.			
4	KVM Display (Optional, Quote Compulsory)	1		
	1U Rack mountable 17" OSD with attached			
	Keyboard & touchpad with USB with			
	accessories to connect with the Primary			
	Master node.			
5	Fully Automated System Provisioning	1		
	Operating System - Latest stable version of			
	CentOS			
	Clustering tool – xCAT (opensource)/openHPC			
	Scheduler – SLURM/PBS Pro (Open)			
	Scheduler configuration inputs has to be taken			
	from the TIFR-H HPC Committee			
	Cluster management tools - Ganglia, PDSH,			
	PDCP, Nagios, automated emails, monthly			
	report generation, etc., TIFR-H HPC System			
	Administrators will be providing the other			
	required management tools and			
	functionalities during installation.			
6	Software	1		
	Open Source Application Software list for			
	installation: FFTW, P3DFFT, GERRIS,,			
	LAMMPS, QUANTUM ESPRESSO, NAMD,			
	GROMACS etc.,			
	Scientific programs: Lapack, scalapack,			
	Python, Numpy, SciPy, Setuptools, IPython,			
	pythondev, pythonnumpy, python matplotlib,			
	pythontk, pythonlxml, PyReadline,			
	MDAnalysis.			
	Editors: Vim, Gvim, GNU plot, NTPD, GRACE,			
	BC, VMD, Perl, etc.,			
	Compilers and Libraries: OpenMP, MPI,			

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	C/C++ and FORTRAN compilers, gsl libraries				
	should be installed.	_			
7	Warranty, Support, Terms & Conditions	1			
7.1	Comprehensive onsite hardware and	1			
	software warranty for 5 Years				
	If TIFR-H request for OS/software upgrade				
	due to their functionality requirement, the				
	bidder/OEM should reinstall/Upgrade the OS				
	and clustering tools and benchmark the				
	cluster and re-commission the HPCC at any				
	point of time during the warranty period at no				
-	cost to purchaser.				
	Training for general system administration				
	with documentation including tasks such as				
	user/node management, installation/upgrade,				
	queuing system management and file system management.				
	One L3 level trained personnel should be				
	available to help either remotely (8.00 AM to				
	5.00 PM, 6 Days a week) or NBD onsite for				
	technical support for				
	administration/maintenance (both software				
	and hardware levels) of HPC.				
	OEM/Vendor should not change the support				
	engineers assigned to this any tickets before				
	the ticket completion without TIFR-H IT in-				
	charge knowledge.				
	Vendor/OEM engineer should visit TIFR-H				
	every 90 days and carry out proper hardware				
	& software health check of HPC cluster and				
	submit report of the same to the IT in-charge.				
	Vendor will be responsible to protect user				
	data during any maintenance in the warranty				
	period. The OEM/Bidder should have automated				
	ticketing system with a dedicated helpdesk				
	email account which is regularly monitored				
	and it should be available to TIFR-H users.				
	An escalation matrix for issues not resolved by				
	the support personnel, with an expected time				
	line, should be clearly mentioned.				
	The person should have enough experience to				
	handle cluster hardware and software				
	troubleshooting to resolve the problems faced				
	by the users. This should include fine tuning of				
	the scheduler's various capabilities.				
	The person should be able to produce				
	required status report of the cluster when				
	asked using the software installed in the				
	cluster to manage it.				

	Faulty parts should be replaced by NBD (Next		
	Business Day).		
7.2	Documentation		
	 C User Creation/Deletion/Modification. D Bringing up and shutting down the cluster. E Disk status monitoring of Master/IO nodes and storage enclosure. F Basic troubleshooting for storage and job scheduler. G Step by step installation guide for node configuration from scratch. H When handing over the cluster the vendor should provide the full design of the cluster installation including the electric connections, network connections, user manual clearly explaining how to use the 		
7.3	cluster. Terms and conditions:		
	Any item not specifically mentioned in the specification but is required for successful implementation of the HPC solution (in the opinion of the vendor) must be brought to our notice and quoted accordingly. The entire solution should fit in a 19" standard IT Rack. At the time of installation, if it is found that some additional hardware or software items are required to meet the operational		
	requirement of the configuration, but not included in the vendor's original list of deliverables, the vendor shall supply such items to ensure the completeness of the configuration at no extra cost. TIFR-H reserves the right to increase or		
	decrease the quantity of the items. Delivery period will be 8 weeks from the date of purchase order. Once delivered to onsite, the installation, commissioning and acceptance testing period will be within 4 weeks from the date of delivery of equipment.		
	The vendor immediately after the award of the work shall prepare a detailed plan of installation as proposed to be followed by placement of the equipment, etc. All vendors participating in this tender must wight the TIER Heite for a complete site survey.		
	visit the TIFR-H site for a complete site survey and also meet with the TIFR-H IT team in the pre-bid meeting for detailed discussions and clarifications, if any.		

rack arrangement and cooling requirements		
for hosting the HPCC in the given place.		
All the required CAT6 Patch cables should be		
branded (ISO/IEC 11801) and it should be		
molded cables. It should withstand the heat		
produced at the back of servers.		
Supplier should have direct system integration		
(SI) with the OEM whose product the vendor		
is quoting for. The bidder should have a back-		
to-back agreement with the OEM to supply		
and support the OEM's product and solution in		
India.		
Itemized price list of each hardware item,		
software bundle and service and warranty to		
be given separately and clearly.		
TIFR-H requires that there be a Single Point of		
Contact (SPoC) directly from OEM who is		
responsible for all issues between TIFR-H and		
the OEM/partner who executes this project.		
Service Level Agreement:		
a) In the event of a failure of any of the sub-		
systems or components of the proposed		
solution, the bidder has to ensure that the		
defects are rectified before end of the next		
working day.		
b) Failure to meet the above requirement will		
result in extension of the warranty services		
by 3 days for delay of each day during the		
warranty period.		
Therefore, the bidders along with the OEMs		
have to put systems and processes in place to		
address the above during the period of the		
contract.		
Bidder should install and accommodate the		
entire solution in a provided 42U rack with		
built-in cooling.		
Entire solution to be implemented in 12		
weeks' time line. Delay in delivery will have		
penalty. TIFR-H reserves the right to cancel		
 the order if it is not deployed even after that.		+
Delay due to TIFR-H will not be considered for		
computing penalty.		

Schedule of experience of last five years Annexure - D

Please furnish list of firms/offices where you have undertaken similar jobs (please use additional sheets, if necessary)

S.No	Name of company with full address	Name of the project	Purchase order No & Date	Brief description	Value (INR)
Signat	ture		1		
Name	& Contact details				
Design	nation				
Name	of the company				
Date		·	·		
Seal o	f the company				

Audited Annual Turnover

Annexure - E

S.No	Financial/			Annual Turnover
	Accounting year	Profit (Rs.)	Loss (Rs.)	(INR)
1	2016-2017			
2	2015-2016			
3	2014-2015			

AUTHORIZED SIGNATORY WITH SEAL

Note:

This Annexure – E should be certified by Chartered Accountant (CA) as per the format given above duly signed and stamped by the CA on the letterhead.

N.B

The right to suspend the NIQ/IIT process or part of the process, accept or reject any or all NIQ/IITs at any stage of the process and/or to modify the process or any part thereof anytime without assigning any reasons thereto is reserved by TIFR-H-TIFR without any obligation or liability whatsoever.

Schedule of deviations from specifications/conditions

Annexure - F

All deviations from the syschedule.	pecifications/conditions shall be filled in by the bidder in this
technical specifications/ C deviation is envisaged)	es that the above mentioned are the only deviations from the commercial terms and conditions of this tender. (State NIL if no
Signature	
Name	
Designation	
Name of the company	
Date	
Seal of the company	

Annexure - G

Supply, Installation and Commissioning of High Performance Computing (HPC) Cluster

TIFR-H Enquiry No & Date:
Due date:
Bidder's Quotation Ref No. & Date:

Financial Bid

All the Bidders should quote their offer in the following format for uniformity.

Mandatory Items

S.No	Item Description	Qty	Rate per unit (Currency)	Fotal Amount (Currency)
A				
1	Master + Storage Node	1		
2	Compute Nodes	1152 CPU Cores		
3	Network/Interconnect & Connectivity	2		
4	Fully Automated System Provisioning	1		
В	Ex-Works Cost (Duly packed Airworthy/Sea Worthy of international standard)			
С	FOB/FCA Cost (Name of the Airport)			
D	CIP/CIF Cost (Upto Hyderabad Airport) (all inclusive i.e. Cost of Goods, Packing, Insurance, Inland transportation, Freight etc.)			

Optional items:

S.No	Item Description	Qty	Rate per unit (Currency)	Total Amount (Currency)
A				
1	KVM Display (Optional, Quote Compulsory)	1		
2	6 th Year Additional Warranty (Item wise price for every items should be provided separately)	1		
3	7 th Year Additional Warranty (Item wise price for every items should be provided separately)	1		
4	Intel Parallel Studio Composer edition 1 Seater license with one year support	1		
5	Miscellaneous			
В	Ex-Works Cost (Duly packed Airworthy/Sea Worthy of international standard)			
С	FOB/FCA Cost (Name of the Airport)			
D	CIP/CIF Cost (Upto Hyderabad Airport) (all- inclusive i.e. Cost of Goods, Packing, Insurance, Inland transportation, Freight etc.)			

Note:

- 1. All the column should be appropriately filled and not left blank.
- 2. Do not include any other charges, taxes, duties etc. in the Basic Cost of the item.
- 3. Any accessories, optional items should be shown separately using above format.
- 4. Use separate sheet for detail description, specification of the item, but prices should be quoted in same format.
- 5. Prices quoted in Indian Currency should be on F.O.R. basis and mentioned separately using different table format showing all the applicable taxes/Duties like GST, service tax, Freight & Transportation charges and installation charges etc.
- 6. TIFR-H being educational & research institute, discounted price shall be offered.

Signature	of the	Bidder
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	Signature of
Name, Address contact no & email id of the bidder	
Company Name with company's Stamp or Seal	
Date:	
Place:	

TATA INSTITUTE OF FUNDAMENTAL RESEARCH

Plot No.36/P, Gopanpally Village, Serilingampally Mandal, Ranga Reddy District. Hyderabad - 500 107, Telangana, India. (PURCHASE SECTION)

Terms and Conditions

1. PART "A" (Technical Bid) consisting of Technical Bid with Commercial Terms and PART "B" (Financial Bid) consisting of only Price shall be submitted in separate sealed envelopes duly superscribed with the tender enquiry number, and the due date in bold letters, addressed to the Administrative Officer, Tata Institute of Fundamental Research, Plot No.36/P, Gopanpally Village, Serilingampally Mandal, Ranga Reddy District. Hyderabad-500 107, Telangana, India. The envelopes should be clearly marked on top as either PART "A" or PART "B".

The two sealed covers should be further put in a master cover superscribed with the Tender Enquiry No., Due Date in bold letters, addressed to the Purchase Officer, Tata Institute of Fundamental Research, Plot No.36/P, Gopanpally Village, Serilingampally Mandal, Ranga Reddy District. Hyderabad-500 107, Telangana, India. The sealed master envelop has to be delivered by hand/courier at the security Gate Office of TIFR-TCIS on or before 13.00 hrs. on the due date specified. The technical bid will be opened in the presence of attending tenderers at 15.00 hrs. on the due date at Purchase Section, TIFR-TCIS, Hyderabad. Tenders submitted after 13.00 hrs. on due date will not be considered.

- 2. In case the PART "A" and Part "B" bids are not sealed in separate envelopes the tender will be rejected.
- 3. The technical bid should not contain any indication of the price. The bidder should take special care not to mention anything related to pricing and costing aspect of whatsoever nature. The technical bid should include/contain only technical specifications, technical literature, drawing, quantity, manufacturing and delivery schedule, mode and terms of payment, mode of dispatch, the quantum and percentage of statutory levies payable by the purchaser as extra and all related commercial terms and conditions for the supply and for the services like erection and commissioning to be rendered by the tenderer. The details of the validity of the tender should also be indicated along with the commercial details.
- 4. After scrutiny of Technical Bids, Financial bids of only those bidders who are shortlisted on technical basis will be opened at on later date. The opening date, time and venue will be intimated to the technically successful bidder.

5. Tender Document Fee:

- a. For Indian Supplier: Tender fee for Rs. 700/- (Non-refundable) in the form of D.D. in favour of "TIFR Centre for Interdisciplinary Sciences", payable at Hyderabad to be enclosed with the Technical Bid (Part A).
- b. For Foreign Supplier: Tender fee of USD 100 (Non-refundable) in the form of advance cheque in favour of "TIFR Centre for Interdisciplinary Sciences", payable at Hyderabad to be enclosed with the Technical Bid (Part A).

6. Earnest Money Deposit (EMD):

- a. For Indian Supplier: Earnest Money Deposit (EMD) for Rs. 3,90,000 /-in the form of D.D. in favour of "TIFR Centre for Interdisciplinary Sciences", payable at Hyderabad to be enclosed along with the technical Bid (Part A).
- b. For Foreign Supplier: Earnest Money (EMD) for USD 5700 in the form of advance cheque in favour of "TIFR Centre for Interdisciplinary Sciences", payable at Hyderabad to be enclosed with the Technical Bid (Part A).

EMD shall be interest free and it will be refunded to the unsuccessful bidder without any interest. EMD will be forfeited if the bidder withdraws or amend impairs orderogates from the tender in any respect.

- 7. Bidders who have not accepted the job/order awarded to them or withdrawn from the tender process OR whose EMD/Security deposit has been forfeited in the past their bids will not be considered and treated as ineligible / disqualified.
- 8. After downloading the documents please inform your company details such as name, address, telephone nos., contact person and email address etc. by email to us (purchasegroup@tifrh.res.in) to enable us to inform prospective bidder for any corrigendum/changes if any; in the Tender document before due date.
- 9. Quotations must be valid for a period of 180 days from the due date.
- 10. Tenders containing correction, overwriting will not be considered. Late or delayed/Unsolicited quotations/offers shall not be considered at all. These will be returned to the firms as it is. Post tender revisions/corrections shall also not be considered.
- 11. Tenderer should sign on all the pages of the technical bid and the price bid.
- 12. The price quoted for Import item must be on following basis:
 - a. Ex-Work/factory duly packed airworthy/seaworthy and of international standard
 - b. FOB/FCA
 - c. CIF Hyderabad, Airport Port (all-inclusive i.e. Cost of Goods, Packing, Insurance, Inland transportation, freight etc.)

For local item /supply, offer should be on FOR basis (i.e. total landed cost for delivery at TIFR-TCIS, Hyderabad).

The dimension of the item (viz. H, W, L, weight etc.) shall be specifically stated and also mention whether the mode of shipping the item is Airworthiness / Seaworthiness or both. Accordingly the mode of shipment will be decided by TIFR-TCIS.

Price must be quoted in the Price Bid Format attached herewith as "Part -B" (Financial Bid).

- 13. If equipment offered is to be imported, arrangements for import will be made by us.
- 14. Tenders who do not comply with any of the condition are liable to be rejected.
- 15. The Institute shall be under no obligation to accept the lowest or any other tender received in response to this tender notice and shall be entitled to reject any tender without assigning any reason whatsoever.
- 16. TIFR reserves the right to place the order for part/reduced quantity than what is specified in the tender.
- 17. **Performance Security**: The Successful bidders should deposit @ 10% of Purchase Order value as Performance Security against issue of order/contract at the earliest. The performance security shall be in the form of Demand Draft in favour of "TIFR Centre for Interdisciplinary Sciences, Hyderabad" payable at Hyderabad (or) Bank Guarantee from State Bank of India & Associates (or) any one of the Nationalized Banks.

The Performance Security will be returned back to the successful supplier on receipt of the Performance Bank Guarantee (or) The 10% Performance Security Deposit may be extended as Performance Bank Guarantee valid for 60 days beyond the date of completion of all contractual obligations of the supplier including warranty period. Vendor should clearly mention their acceptance to this effect in their quote.

Performance Bank Guarantee: Performance Bank Guarantee for 10% of the value of supply should be provided and it should be valid for 60 days beyond the date of completion of all contractual obligations of the supplier including warranty period. Performance Bank Guarantee should be from Nationalised Bank. In case Performance Bank Guarantee is not provided, 90% payment only would be released and balance after 60 days beyond the date of completion of all contractual obligations of the supplier including warranty period. Vendor should clearly mention their acceptance to this effect in their quote.

- 18. **PAYMENT TERMS:** 80% payment shall be made through irrevocable L/C on presentation of complete and clear shipping documents and balance 20% of the amount shall be released after the receipt, installation, commissioning and acceptance of the equipment and on submission of "Performance Bank Guarantee (PBG)" or "Standby Letter of Credit" for an amount equivalent to 10% of the Purchase Order Value. The PBG or "Standby Letter of Credit" shall be valid for a period of 60 days beyond the date of warranty period. The PBG should be from State Bank of India & Associates (or) any one of the Nationalized Banks.
- 19. PAYMENT TERMS FOR INDIGENOUS ITEMS: 100% payment shall be released after receipt, installation, commissioning and acceptance of the equipment.
- 20. Repair / replacement if required any during the warranty period, necessary customs clearance charges / customs duty charges, freight charges for sending back the repair material to supplier and import freight charges of replacement should be borne by the supplier.

- 21. For Import cases: No Agency commission will be paid as per Govt. of India rules.
- 22. All bank charges outside India to supplier's account only.
- 23. TIFR is exempted from paying of Custom Duty under the notification No.51/96 dated 23.07.1996, Excise Duty under the notification No.10/97 dated 01.03.1997, for all procurements/supply meant exclusively for Educational, scientific and research purpose. Whenever the exemption certificate not honored by the authorities, the applicable duty will have to be paid. Hence Excise & Custom duties, if any, should be shown separately.

TIFR is a public funded research institute and is entitled to concessional rate of GST @ 5% for certain items supplied for research purpose vide notification no. 45/2017 (CGST) and 45/2017 (IGST) dated 14th Nov, 2017. The offer should be submitted after fully considering the above notification.

24. **TAXES:** TIFR does not have any exemption/concession on payment of Sales Tax and we are not authorized to issue any Sales Tax Form 'C' & 'D'.

Deduction of Indian Income Tax Deduction at Source: The Deduction of Indian Income Tax Deduction at source (TDS) will be deducted as per IT Act. The taxes at the time of actual utilization of service etc. will be deducted if applicable any.

GST rule will be applicable with effect from 01.07.2017. The applicable TDS /other charges if any as per GST rule will be deducted as per new GST regime.

TIFR-Hyderabad GST NO: 36AAATT3951F2ZG.

- 25. Bidders, please provide the PAN No., Bank Details, email ID, Contact person details, GST No etc.
- 26. The Supplier shall arrange to ship the ordered materials within the mutually agreed delivery period mentioned in the order unless extended with/without penalty. Please mention the Delivery Period Clearly in the Bid, however effort to be taken to deliver the materials at the earliest.
 - a. In case of delay in supply on part of the supplier, a penalty @0.5% per week of order value will be charged for delayed period subject to a maximum of 10% order value.
 - b. If the delay in the shipment of the ordered materials attributable to the supplier exceeds agreed time period from the date of original agreed upon date of shipment and extended with/without penalty, the TIFR-TCIS, Hyderabad shall have the right to cancel the contract / purchase order and recover the liquidated damages from other dues of the party or by legal means. It will also affect the other/future business dealings with such suppliers.
 - c. The same rate of penalty shall be applicable for late installation of the equipment/instrument also.

- 27. **COMMENCEMENT OF WARRANTY PERIOD:** The warranty period of an item shall commence from the date of receipt of the item in good working condition and satisfactory installation/commissioning/demonstration at the project site.
- 28. **ANNUAL MAINTENANCE CHARGES:** The bidder must mention in the quotation, the rate/amount of annual maintenance charges, if we opt for maintenance contract after expiry of the warranty period.
- 29. Specifications are basic essence of the product. It must be ensured that the offers must be strictly as per our specifications. At the same time it must be kept in mind that merely copying our specifications in the quotation shall not make the parties eligible for consideration of the quotation. A quotation has to be supported with the printed technical leaflet/literature of the quoted model of the item by the quoting party/manufacturer.
- 30. **OBSERVANCE OF LOCAL LAWS:** Wherever applicable (particularly for Local vendors), the vendor / contractor shall comply with all law, statutory rules & regulations etc. The vendor/ contractor shall obtain all necessary permits / approval from the local Governing Body, Police, and other concerned Authorities as may be required under law. The vendor /contractor shall pay all types of taxes, fees, license charges, deposits, duties, tolls, royalty or other charges that may be leviable account of any of the operations connected with the execution of this work/ contract.
- 31. In case of any interpretational issues arises in this tender, the interpretation/decision of TIFR Hyderabad shall be final and binding on the bidder.
- 32. It is the responsibility of the vendor to make sure that the system being proposed can be exported to India with TIFR Hyderabad as the end user. All clarificatory documentation must be submitted with the Bid.
 - 33. TIFR TCIS reserves the right to ask for or to provide any clarification, changes after the release of this tender. Any changes or clarifications provided by TIFR-TCIS, Hyderabad may be checked at TIFR-TCIS website: https://www.tifrh.res.in/index.php/commercial-tenders

ADMINISTRATIVE OFFICER (PURCHASE SECTION) TIFR, HYDERABAD